

You are here: [Products](#) » [Heatsinks f.cool](#) » [Heatsinks and active heatsinks for processors](#) » [Heatsinks for DIL-IC, PLCC and SMD](#) » [ICK SMD B ...](#) » [ICK SMD B 19](#)



Heatsinks f.cool

- ▶ Profile heatsinks and fluid coolers
- ▼ Heatsinks and active heatsinks for processors
  - Heatsinks for PGA
  - Heatsinks for BGAs
  - Pin heatsinks
  - Heatsinks for LEDs
  - [Heatsinks for DIL-IC, PLCC and SMD](#)
  - Passive heatsinks for processors
  - Active heatsinks for processors
  - technical data for the fans
- ▶ Board Level heatsinks
- ▶ Cooling aggregates
- ▶ Accessories for electronic components
- ▶ **Cases f.case**
- ▶ **Connectors f.con**

Heatsinks for DIL-IC, PLCC and SMD

ICK SMD B ...

ICK SMD B 19 MI

19 x 4,8 mm, for SMD components and others

Data sheet

add to request



Features

Technical Drawing

Variants

Service

width B	19 mm
height	4.8 mm
plate thickness	1 mm
length	19 mm
thermal resistance $R_{th}$	22 K/W
surface	solderable surface